



Headquartered in Switzerland (Europe), Synova is the pioneer of a revolutionary hybrid laser processing technology – Laser MicroJet®. Synova provides state-of-the-art high precision material processing in the semiconductor industry as well as for emerging applications in the electronics, MEMS, solar cell, flat panel display and medical industries.

To support our new Micro Machining Centers, we are looking for an

Application Engineer

based in Taiwan

In this position you will:

- Within our Micro Machining Center, process customer samples to demonstrate our MicroJet machine capabilities
- Optimize the processing for each customer sample to maximize speed, yield and machining quality and precision
- Provide to customers comprehensive samples processing report to obtain where appropriate its buy-in
- Show to customers our MicroJet machines functionalities and capabilities
- Conduct customers training on the operation of our equipment
- Lead customer sign-off for the application during the machine acceptance phase
- Upon request, optimize or troubleshoot at the customer site the production processing of our equipment

For this position, we are looking for candidates with the following profile:

- BS or MS in Material Science Engineering
- Several year hand experience in the semiconductor and machine tool industry
- At least three years in customer facing activities
- Proven analytical skills and technical judgment
- Flexible and ready to travel from time to time
- Excellent verbal and written communication skills in English
- Local candidates only. No relocation provided.

Do you want to join our fast-growing, innovative and progressive company? If you feel that you have the qualities to make an effective contribution, please apply now.

SYNOVA SA

Innovative Laser Systems

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